

CHONGQING CLOUDCHILD TECHNOLOGY CO., LTD

SOT-23 Plastic-Encapsulate MOSFETS

BSS84

P-Channel Power MOSFET

V _{DSS}	R _{DS(ON)} (Typ.)	I _D
F0.\/	1.7Ω@-10V	0.404
-50 V	1.9Ω@-4.5V	-0.13A

DESCRIPTION

The BSS84 provides excellent $R_{\text{DS}(\text{ON})}$ with low gate charge.

It can be used in a wide variety of applications.

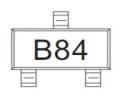
FEATURES

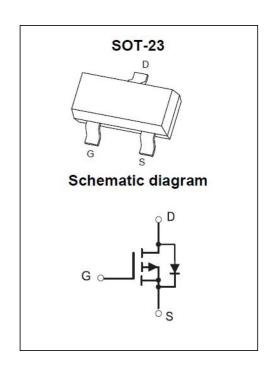
- Trench Technology MOSFET
- Low Gate Charge
- AEC-Q101 Qualified

APPLICATIONS

- Load Switch for Portable Devices
- DC/DC Converter

MARKING





ABSOLUTE MAXIMUM RATINGS(T_j=25℃unless otherwise specified)

Parameter	Symbol	Value	Unit	
Drain - Source Voltage		V _{DS}	-50	V
Gate - Source Voltage		V _G s	±20	V
Continuous Drain Current ¹	T _A = 25°C	ID	-0.13	Α
Pulsed Drain Current ²		I _{DM}	-0.52	Α
Power Dissipation ⁴	T _A = 25°C	P _D	360	mW
Thermal Resistance from Junction to Ambient ⁵		R _{θJA}	417	°C/W
Junction Temperature	TJ	175	$^{\circ}$	
Storage Temperature		T _{STG}	-55~ +175	$^{\circ}$

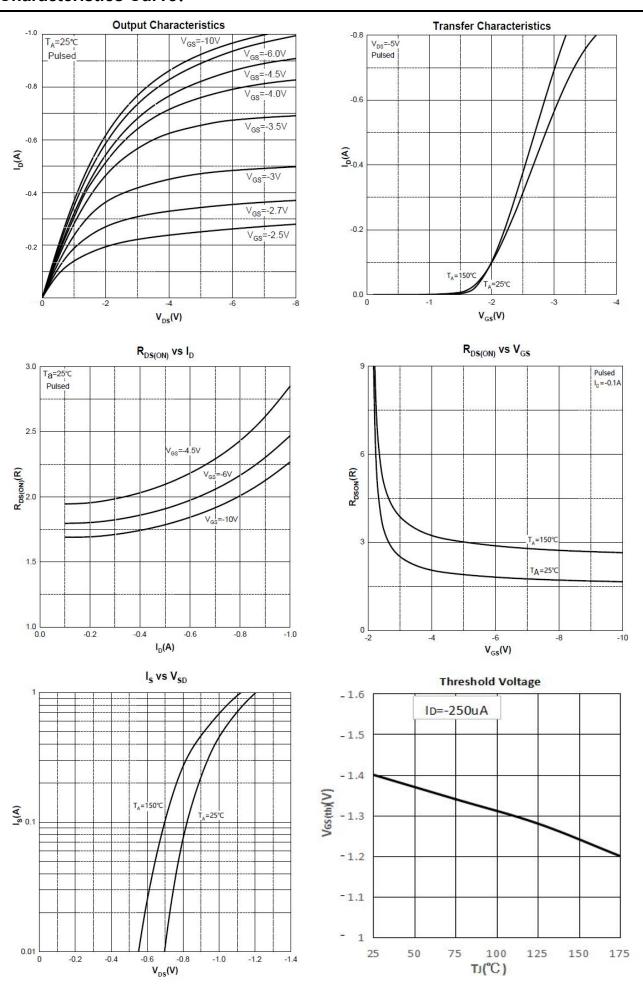
MOSFET ELECTRICAL CHARACTERISTICS(TC=25 $^{\circ}$ C unless otherwise noted)

Parameter Symbol		Test Condition	Min	Туре	Max	Unit
Off Characteristics	•					
Drain – Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0V, I _D = -250μA	-50			V
Zero Gate Voltage Drain Current	IDSS	V _{DS} = -50V, V _{GS} = 0V			-1	μΑ
Gate – Body Leakage Current	I _{GSS}	$V_{GS} = \pm 20V, V_{DS} = 0V$			±100	nA
On Characteristics ³						
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = -250\mu A$	-0.9	-1.4	-2.0	V
Duning and the second of the s	В	V _{GS} = -10V, I _D = -0.1A		1.7	5	Ω
Drain-source On-resistance	R _{DS(on)}	V _{GS} = -4.5V, I _D = -0.1A		1.9	6	
Dynamic Characteristics	•			•		
nput Capacitance C _{iss}				32.9		
Output Capacitance	Coss	V _{DS} = -25V, V _{GS} = 0V, f = 1MHz		5.48		pF
Reverse Transfer Capacitance	C _{rss}			3.31		
Gate Resistance	R_g	V _{DS} = 0V, V _{GS} = 0V, f = 1MHz		73		Ω
Switching Characteristics						
Total Gate Charge	Qg			0.62		
Gate-source Charge	Q _{gs}	V _{DS} = -10V, V _{GS} = -10V, I _D = -0.1A		0.13		nC
Gate-drain Charge	Q _{gd}			0.11		
Turn-on Delay Time	t _{d(on)}			11		
Turn-on Rise Time	t _r	V _{DD} = -30V, V _{GS} = -10V,		6		_
Turn-off Delay Ttime	$t_{d(off)}$	$R_L = 110\Omega$, $R_G = 50\Omega$		19		ns
Turn-off Fall Ttime	t _f			8		
Source - Drain Diode Characteristics						
Diode Forward Voltage ³	V _{SD}	V _{GS} = 0V, I _S = -0.1A			-1.2	V

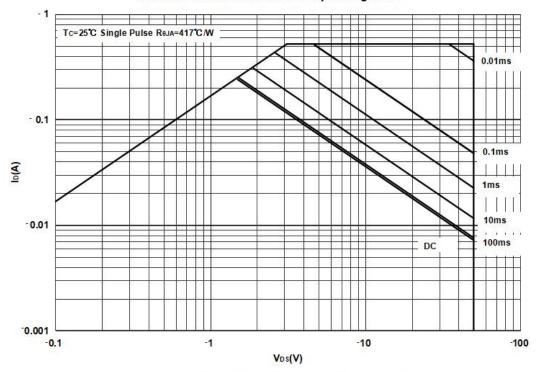
Notes:

- 1. The maximum current rating is limited by Chip.
- 2. Pulse Test : Pulse Width \leq 10 μ s, duty cycle \leq 1%.
- 3. Pulse Test : Pulse Width \leq 300 μ s, duty cycle \leq 2%.
- 4. The power dissipation PD is limited by TJ(MAX) = 175°C.
- 5. Device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with TA =25°C.

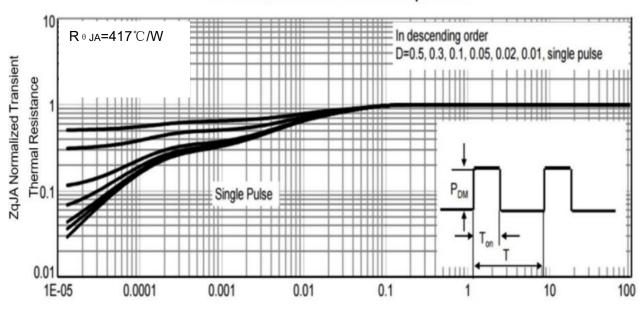
Characteristics Curve:



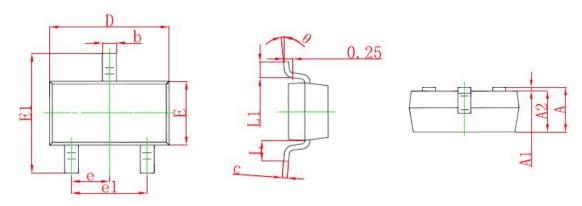
Maximum Forward Biased Safe Operating Area



Normalized Thermal Transient Impedance

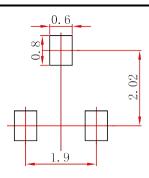


SOT-23 Package Outline Dimensions



Complete	Dimensions	In Millimeters	Dimension	s in inches
Symbol	Min	Max	Min	Max
Α	0.900	1.150	0.035	0.045
A1	0.000	0.100	0.000	0.004
A2	0.900	1.050	0.035	0.041
b	0.300	0.500	0.012	0.020
С	0.080	0.150	0.003	0.006
D	2.800	3.000	0.110	0.118
E	1.200	1.400	0.047	0.055
E1	2.250	2.550	0.089	0.100
е	0.950	TYP	0.037	TYP
e1	1.800	2.000	0.071	0.079
L	0.550	0.550 REF		REF
L1	0.300	0.500	0.012	0.020
θ	0°	8°	0°	8°

SOT-23 Suggested Pad Layout



Note:

- 1.Controlling dimension:in millimeters.
- 2.General tolerance:± 0.05mm.
- 3. The pad layout is for reference purposes only.

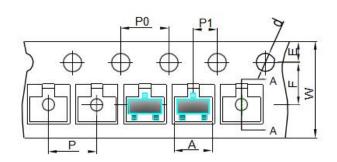
NOTICE

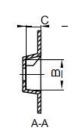
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SOT-23 Tape and reel

SOT-23 Embossed Carrier Tape



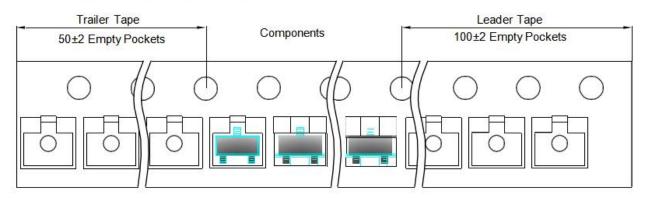


Packaging Description:

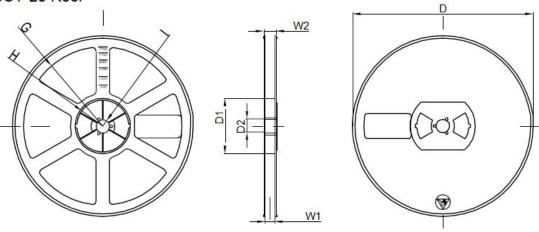
SOT-23 parts are shipped in tape. The carrier tape is made from a dissipative (carbon filled) polycarbonate resin. The cover tape is a multilayer film (Heat Activated Adhesive in nature) primarily composed of polyester film, adhesive layer, sealant, and anti-static sprayed agent. These reeled parts in standard option are shipped with 3,000 units per 7" or 17.8cm diameter reel. The reels are clear in color and is made of polystyrene plastic (anti-static coated).

			1	Dimensions a	re in millime	ter				
Pkg type	Α	В	С	d	E	F	P0	Р	P1	W
SOT-23	3.15	2.77	1.22	Ø1.50	1.75	3.50	4.00	4.00	2.00	8.00

SOT-23 Tape Leader and Trailer







Dimensions are in millimeter								
Reel Option	D	D1	D2	G	Н	1	W1	W2
7"Dia	Ø178.00	54.40	13.00	R78.00	R25.60	R6.50	9.50	12.30

REEL	Reel Size	Box	Box Size(mm)	Carton	Carton Size(mm)	G.W.(kg)
3000 pcs	7 inch	30,000 pcs	203×203×195	120,000 pcs	438×438×220	

Date of change	Rev#	revise content
2023/2/21	A/0	/